

### **Peak EMI Reducing Solution**

#### **Features**

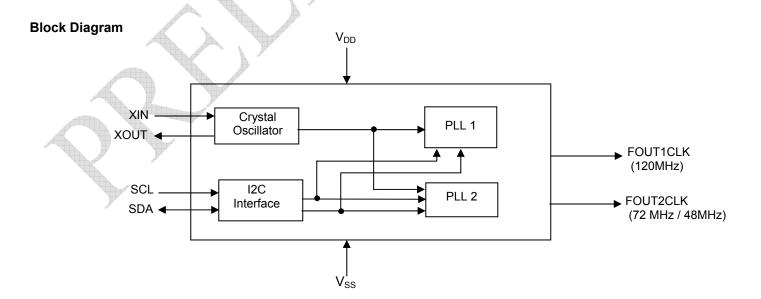
- Generates an EMI optimized clocking signal at output.
- Input frequency 14.31818MHz.
- Frequency outputs:
  - 120MHz (modulated) default.
  - 72MHz (modulated) or 48MHz (modulated) selectable via I2C
- ± 1% Centre spread.
- Modulation rate: 40KHz.
- Byte Write via I2C
- Supply voltage range 3.3V ± 0.3V.
- Available in 8-pin SOIC Package.
- Available in Commercial and Industrial Temperature ranges.

#### **Product Description**

The ASM3P2508A is a versatile spread spectrum frequency modulator. The ASM3P2508A reduces electromagnetic interference (EMI) at the clock source.

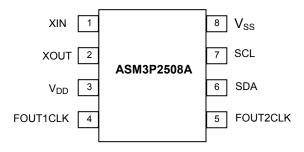
The ASM3P2508A allows significant system cost savings by reducing the number of circuit board layers and shielding that are required to pass EMI regulations. The ASM3P2508A modulates the output of PLL in order to spread the bandwidth of a synthesized clock, thereby decreasing the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most clock generators. Lowering EMI by increasing a signal's bandwidth is called spread spectrum clock generation.

The ASM3P2508A has a feature to power down the 72MHz/48MHz output by writing data into specific registers in the device via I2C. By writing a '0' into bit 1 of Byte 0, the PLL block generating 72MHz / 48MHz can be powered down. Writing '0' into bit '7' of Byte 1 selects an output of 72 MHz on FOUT2CLK while a '1' at the same location selects a 48 MHz clock output. However, the I2C block, crystal oscillator, and the PLL block generating 120MHz would be always running.





# **Pin Configuration**



# **Pin Description**

Pin Name	Туре	Description
XIN	I	Connection to crystal
XOUT	0	Connection to crystal
$V_{DD}$	Р	Power supply for the analog and digital blocks
FOUT1CLK	0	Clock output-1 (120MHz) - default
FOUT2CLK	0	Clock output-2 ( 72MHz / 48MHz)
SDA	I/O	I2C Data
SCL	I	I2C Clock
V <sub>SS</sub>	Р	Ground to entire chip

## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit
$V_{DD}, V_{IN}$	Voltage on any pin with respect to Ground	-0.5 to +4.6	V
$T_{STG}$	Storage temperature	-40 to +85	°C
T <sub>A</sub>	Operating temperature	0 to 70	°C
Ts	Max. Soldering Temperature (10 sec)	260	°C
$T_J$	Junction Temperature	150	°C
T <sub>DV</sub>	Static Discharge Voltage	2	KV
- 50	(As per JEDEC STD22- A114-B)	_	
Note: These are s device relia	stress ratings only and are not implied for functional use. Exposure to absolute maximum ratings f bility.	or prolonged periods of time r	may affect

# **Operating Conditions**

Symbol	Parameter	Condition / Description	Min	Тур	Max	Unit
$V_{DD}$	Supply Voltage	3.3V ± 10%	3	3.3	3.6	V
T <sub>A</sub>	Ambient Operating Temperature Range		-10		+70	°C
F <sub>XIN</sub>	Crystal Resonator Frequency			14.3	1818	MHz
	Serial Data Transfer Rate	Standard Mode	10		100	Kb/s
$C_L$	Output Driver Load Capacitance				15	pF



February 2007 Giving you the edge ASM3P2508A

rev 1.4

## **DC Electrical Characteristics**

(Test Condition : All the parameters are measured at room temperature (25°C) , unless otherwise stated)

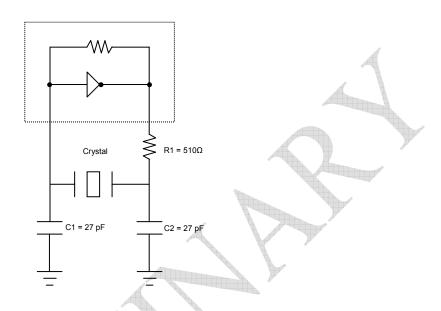
Parameter	Symbol	Conditions / Description	Min	Тур	Max	Unit
Overall						
Supply Current, Dynamic	I <sub>cc</sub>	V <sub>DD</sub> =3.3V, F <sub>CLK</sub> =14.31818MHz, C <sub>L</sub> =15pF	40	49	60	mA
Supply Current, Static	I <sub>DD</sub>	V <sub>DD</sub> = 3.3V, Software Power Down*	27	35	43	mA
All input pins						
High-Level Input Voltage	V <sub>IH</sub>	V <sub>DD</sub> =3.3V	2.0	-	V <sub>DD</sub> +0.3	V
Low-Level Input Voltage	V <sub>IL</sub>	V <sub>DD</sub> =3.3V	V <sub>SS</sub> -0.3		0.8	V
High-Level Input Current	I <sub>IH</sub>		-1		1	μΑ
Low-Level Input Current (pull-up)	I <sub>IL</sub>		-20	-36	-80	μΑ
Clock Outputs (FOU	T1CLK, FOUT2	CLK)				
High-Level Output Voltage	V <sub>OH</sub>	V <sub>DD</sub> = 3.3V, I <sub>OH</sub> = 20mA	2.5	_	3.3	V
Low-Level Output Voltage	V <sub>OL</sub>	V <sub>DD</sub> = 3.3V, I <sub>OL</sub> = 20mA	0	-	0.4	V
Output Impodance	Z <sub>OH</sub>	V <sub>O</sub> =0.5V <sub>DD</sub> ; output driving high	-	29	-	
Output Impedance	Z <sub>OL</sub>	Vo=0.5V <sub>DD</sub> ; output driving low	-	27	-	Ω
* FOUT1CLK (120MHz) is fu	inctional and not loa	ded				

### **AC Electrical Characteristics**

Parameter	Symbol	Conditions/ Desc	Min	Тур	Max	Unit		
Rise Time	tr	$V_0 = 0.8V \text{ to } 2.0V; C_L = 15pF$	FOUT1CLK	640	680	750	20	
Rise Tille	L <sub>r</sub>	V <sub>0</sub> = 0.6V to 2.0V, G <sub>L</sub> = 15μF	FOUT2CLK	440	480	600	pS	
Fall Time	t <sub>f</sub>	$V_0 = 2.0 \text{V to } 0.8 \text{V}; C_L = 15 \text{pF}$	FOUT1CLK	660	720	800	pS	
i ali Tillie	ч	V <sub>0</sub> = 2.0V to 0.6V, C <sub>L</sub> = 13β1	FOUT2CLK	460	520	570	ρο	
Clock Duty Cycle	t <sub>D</sub>	Ratio of pulse width (as measure to next falling edge at 2.5V) to o		45	-	55	%	
Frequency		Output Frequency =120MHz		-	±2.73	-	%	
Deviation f <sub>D</sub>		Output Frequency =72MHz /48 MHz			±1.78	-	%	
Jitter, Long		On rising edges 500 uS apart at 2.5 V relative to an ideal clock, PLL B inactive *			45	-	22	
Term	Tj <sub>(LT)</sub>	On rising edges 500 uS apart a ideal clock, PLL B active *	t 2.5 V relative to an	-	165	-	pS	
Jitter, peak to	Ti	From rising edge to next rising edge at 2.5 V, PLL B inactive *			110	-	pS	
peak	Tj <sub>(ΔT)</sub>	From rising edge to next rising PLL B active *	From rising edge to next rising edge at 2.5 V, PLL B active *			-	ρЗ	
Clock Stabilization Time	t <sub>STB</sub>	Output active from power up, R Software Power Down	-	125	-	μS		
* CL = 15 pF, Fxin =	* CL = 15 pF, Fxin = 14.31818MHz							



# **Typical Crystal Oscillator Circuit**



# **Typical Crystal Specifications**

to to the second					
Fundamental AT cut parallel resonant crystal					
Nominal Frequency	14.31818MHz				
Frequency Tolerance	+/- 50 ppm or better at 25°C				
Operating temperature range	-20°C to +85°C				
Storage Temperature	-40°C to +85°C				
Load Capacitance	18pF				
Shunt capacitance	7 pF maximum				
ESR	25 Ω				

#### **I2C Serial Interface Information**

The information in this section assumes familiarity with I2C programming.

### How to program ASM3P2508A through I2C:

- · Master (host) sends a start bit.
- Master (host) sends the write address D4 (H).
- ASM3P2508A device will acknowledge.
- Master (host) sends the beginning byte location (N = 0, 1).
- ASM3P2508A device will acknowledge.
- Master (host) sends a byte count (X = 1,2)
- ASM3P2508A device will acknowledge.
- Master (host) starts sending byte N through byte (N+X - 1)
- ASM3P2508A device will acknowledge each byte one at a time.
- Master (host) sends a Stop bit.

Controller (Host)	ASM3P2508A (slave/receiver)
Start Bit	A
Slave Address D4(H)	
	ACK
Beginning byte location (=N)	
	ACK
Byte count (=X)	
	ACK
Beginning byte (Byte N)	
	ACK
Next Byte (Byte N+1)	
	ACK
Last Byte (Byte N+X-1)	
	ACK
Stop Bit	

### How to Read from ASM3P2508A through I2C:

- · Master (host) will send start bit.
- Master (host) sends the write address D4 (H).
- ASM3P2508A device will acknowledge.
- Master (host) sends the beginning byte location (N = 0, 1).
- ASM3P2508A device will acknowledge.
- Master (host) will send a separate start bit.
- Master (host) sends the read address D5 (H).
- ASM3P2508A device will acknowledge.
- ASM3P2508A device will send the byte count (X = 1, 2).
- Master (host) acknowledges.
- ASM3P2508A device sends byte N through byte (N+X - 1).
- Master (host) will need to acknowledge each byte.
- Master (host) will send a stop bit.

Controller (Us at)	A CA42D0500 A
Controller (Host)	ASM3P2508A
	(slave/receiver)
Start Bit	
Slave Address D4(H)	
	ACK
Beginning Byte = N	
	ACK
Repeat start	
Slave address D5(H)	
	ACK
	Byte Count (= X)
ACK	
	Beginning byte N
ACK	
	Next Byte N+1
ACK	
	Last Byte (Byte N+X-1)
Not Acknowledge	
Stop Bit	



An example of a Byte Write via I2C to partially 'power down' the device:

ASM3P2508A can be partially 'powered down' using bit 1 of Byte 0. The organization of the register bits for Byte '0' is given with default values below:

Bit								
7	6	5	4	3	2	1	0	
Poev	Posy	Resv	Resv	Resv	Resv	PLL2	PLL1	
INCSV	11031	11031				Enable	Enable	
0	1	0	1	0	1	1	1	

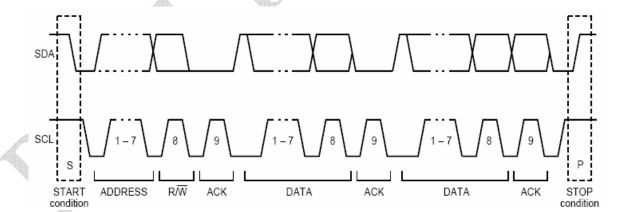
The function of partial power down of the device is of interest to us - that is bit 1 of Byte 0. In the default mode this bit is logic '1'. As such, the Byte 0 default value is

57 (H). To put ASM3P2508A in 'power down' mode, the bit 1 of Byte 0 is to be changed to logic '0'. Hence writing a 55 (H) via I2C into Byte 0 would put the device in partial 'power down' mode where the PLL block generating 72 MHz / 48 MHz would be powered down while I2C block, crystal oscillator, and the PLL block generating 120 MHz would still be active. The organization of the register bits is as below:

	Bit							
7	6	5	4	3	2	1	0	
Resv	Resv	Resv	Resv	Resv	Resv	PLL2	PLL1	
INCSV	11031	11031				Enable	Enable	
0	1	0	1	0	1	0	1	

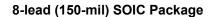
	Byte 0	Byte 1	FOUT1CLK (MHz)	FOUT2CLK(MHz)
Power up default	6F(H)	3F(H)	120	72
48_MHz Mode	6F(H)	BF(H)	120	48
Power down PLL with 72MHz	6D(H)	3F(H)	120	-
Power down PLL with 48MHz	6D(H)	BF(H)	120	-

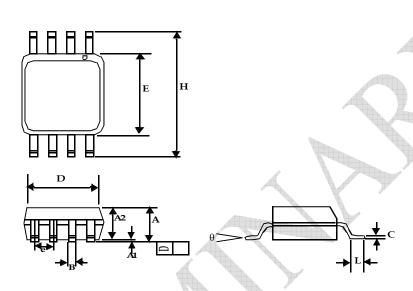
### Figure showing a complete data transfer:





# **Package Information**





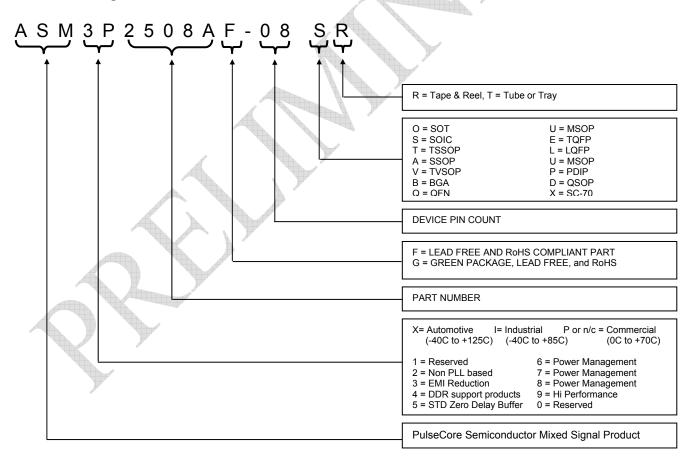
	Dimensions						
Symbol	Inc	hes	Millim	neters			
	Min	Max	Min	Max			
A1	0.004	0.010	0.10	0.25			
Α	0.053	0.069	1.35	1.75			
A2	0.049	0.059	1.25	1.50			
В	0.012	0.020	0.31	0.51			
С	0.007	0.010	0.18	0.25			
D	0.193	BSC	4.90	BSC			
E	0.154 BSC		3.91	BSC			
е	0.050	BSC	1.27 BSC				
Н	0.236 BSC		6.00	BSC			
L	0.016	0.050	0.41	1.27			
θ	0°	8°	0°	8°			



### **Ordering Codes**

Part number	Marking	Package Configuration	Temperature
ASM3P2508AG-08ST	3P2508AG	8-PIN SOIC, TUBE, Green	Commercial
ASM3P2508AG-08SR	3P2508AG	8-PIN SOIC, TAPE AND REEL, Green	Commercial
ASM3I2508AG-08ST	3I2508AG	8-PIN SOIC, TUBE, Green	Industrial
ASM3I2508AG-08SR	3I2508AG	8-PIN SOIC, TAPE AND REEL, Green	Industrial
ASM3P2508AF-08ST	3P2508AF	8-PIN SOIC, TUBE, Pb Free	Commercial
ASM3P2508AF-08SR	3P2508AF	8-PIN SOIC, TAPE AND REEL, Pb Free	Commercial
ASM3I2508AF-08ST	3I2508AF	8-PIN SOIC, TUBE, Pb Free	Industrial
ASM3I2508AF-08SR	3I2508AF	8-PIN SOIC, TAPE AND REEL, Pb Free	Industrial

### **Device Ordering Information**



Licensed under US patent #5,488,627, #6,646,463 and #5,631,920.





PulseCore Semiconductor Corporation 1715 S. Bascom Ave Suite 200 Campbell, CA 95008 Tel: 408-879-9077

Fax: 408-879-9018

Copyright © PulseCore Semiconductor All Rights Reserved Preliminary Information Part Number: ASM3P2508A Document Version: v1.3

Note: This product utilizes US Patent #6,646,463 Impedance Emulator Patent issued to PulseCore Semiconductor, dated 11-11-2003

© Copyright 2007 PulseCore Semiconductor Corporation. All rights reserved. Our logo and name are trademarks or registered trademarks of PulseCore Semiconductor. All other brand and product names may be the trademarks of their respective companies. PulseCore reserves the right to make changes to this document and its products at any time without notice. PulseCore assumes no responsibility for any errors that may appear in this document. The data contained herein represents PulseCore's best data and/or estimates at the time of issuance. PulseCore reserves the right to change or correct this data at any time, without notice. If the product described herein is under development, significant changes to these specifications are possible. The information in this product data sheet is intended to be general descriptive information for potential customers and users, and is not intended to operate as, or provide, any guarantee or warrantee to any user or customer. PulseCore does not assume any responsibility or liability arising out of the application or use of any product described herein, and disclaims any express or implied warranties related to the sale and/or use of PulseCore products including liability or warranties related to fitness for a particular purpose, merchantability, or infringement of any intellectual property rights, except as express agreed to in PulseCore's Terms and Conditions of Sale (which are available from PulseCore). All sales of PulseCore products are made exclusively according to PulseCore's Terms and Conditions of Sale. The purchase of products from PulseCore does not convey a license under any patent rights, copyrights; mask works rights, trademarks, or any other intellectual property rights of PulseCore or third parties. PulseCore does not authorize its products for use as critical components in life-supporting systems where a malfunction or failure may reasonably be expected to result in significant injury to the user, and the inclusion of PulseCore products in such life-supporting systems implies that the manufacturer assumes all risk of such use and agrees to indemnify PulseCore against all claims arising from such use